



PRODUCT : LCD MODULE

LCM NO. **D200N2409V0**

SUPPLIER: 深圳市大显伟业科技有限公司

# SPECIFICATION

**D200N2409V0**

This LCM uses ROHS material

Revision: **A**

## Preliminary

**DX:**

大显确认栏

Quality Assurance Department:

质量部:

Technical Department:

研发部:

Approved by:

核准:

**CUSTOMER:**

客户确认栏

Approved by:

客户核准:



版本: **A**

## REVISION RECORD

[illegible]



## Table of Contents

<b>1. General Description.....</b>	
<b>2. Features.....</b>	
<b>3. Mechanical Specification.....</b>	
<b>4. Mechanical dimension.....</b>	
<b>5. Maximum Ratings.....</b>	
<b>6. Electrical Characteristics.....</b>	
<b>7. Module Function Description.....</b>	
<b>8. Timing Characteristics.....</b>	
<b>9. Backlight CharacEtristic.....</b>	
<b>10. Electro-optical Characteristics.....</b>	
<b>11. Reliability.....</b>	
<b>12. Precautions For Using LCD Modules.....</b>	
<b>13. Using LCD Modules.....</b>	
<b>14.Inspection Specification.....</b>	



## 1.General Description

**D200N2409V0** is a 480RGB\*640 dots matrix TFT LCD module. It has a TFT panel Composed of 1440 sources and 640 gates. The LCM can be easily accessed by micro-controller via parallel interface.

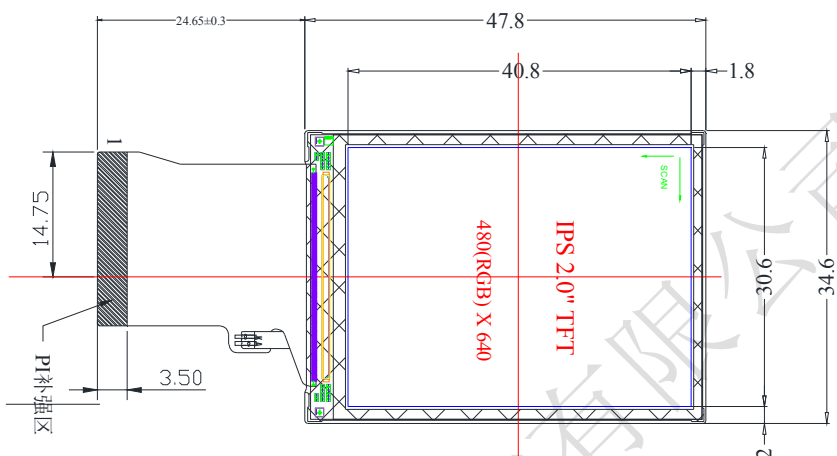
## 2.Features

LCD type	IPS TFT active matrix
Display Format	Graphic 480RGB*640 Dot-matrix
Interface Type	3 line SPI+16 bits RGB & MIPI
Viewing Direction	Free
Driver	LCD:ST7701SN
Display Mode	Normally Black
Display color	16M

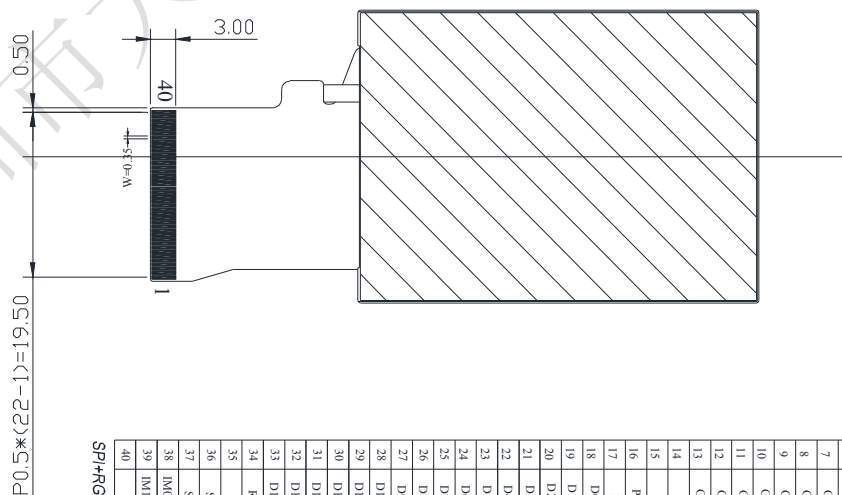
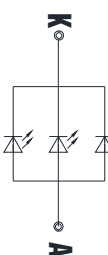
## 3.Mechanical Specification

Item	Specifications	Unit
Dimensional outline	34.6(W)*47.8(H)*1.9(T) (exclude FPC)	mm
Resolution	480RGB*640	Dots
Active area	30.6(W)*40.8(H)	mm
Dot Pitch	0.02125 (W)*0.06375(V)	mm
ASSY.TYPE	COG+FPC	--
WEIGHT	TBD	g


## 4.Mechanical Dimension



### BL CIRCUIT DIAGRAM



No	LED NAME	No	LED NAME
1	LED1	1	LED1
2	LED2	2	LED2
3	VDD	3	VDD
4	GND	4	GND
5	GND	5	DIN
6	GND	6	DOP
7	GND	7	GND
8	GND	8	CLAN
9	GND	9	CLKP
10	GND	10	GND
11	GND	11	DIN
12	GND	12	DIP
13	GND	13	GND
14	VS	14	GND
15	HS	15	GND
16	PC1K	16	GND
17	DE	17	GND
18	DM080	18	GND
19	D1(B1)	19	GND
20	D2(B2)	20	GND
21	D3(B3)	21	GND
22	DM4(B4)	22	GND
23	D5(G0)	23	GND
24	DM6(G1)	24	GND
25	D7(G2)	25	GND
26	DM8(G3)	26	GND
27	DM9(G4)	27	GND
28	D10(G5)	28	GND
29	D11(G6)	29	GND
30	D12(G7)	30	GND
31	D13(G8)	31	GND
32	D14(G9)	32	GND
33	D15(G4)	33	GND
34	RESET	34	RESET
35	CS	35	GND
36	SC1	36	GND
37	SDA	37	GND
38	IM0+VDD	38	IM0+VDD
39	IM1+VDD	39	IM1+GND
40	NC	40	NC

LCD Type		IPS TFT	
Viewing Direction		All O.CLOCK	
Display Mode		TRANSMISSIVE/POSTIVE	
Operating voltage		2.8V~3.3V	
Operating Temp.		-20°C ~ 70°C	
Storage Temp.		-30°C ~80°C	
Controller		COG ST7701S	
		E	
REVISED RECORD			
A		NEW	
		20240509	
深圳市大显伟业科技有限公司			
			
UNIT		SCALE	
mm		1:1	
PAGE		DRAWN BY	
1/1		CHECKED BY	
APPROVED BY		ORG DATE	
PRODUCT NO:		D200N2409V0	

## 技术说明:

**1.未注公差: ±0.2**

## 2. ROHS



## 5. Maximum Ratings

Item	Symbol	Min	Max	Unit	Note
Supply voltage for logic	V <sub>ci</sub> /i <sub>ovcc</sub>	-0.3	3.6	V	
Operating temperature	T <sub>opr</sub>	-20	70	°C	
Storage temperature	T <sub>str</sub>	-30	80	°C	
Humidity	RH	---	90	%RH	60°C

## 6. Electrical Characteristics

V<sub>SS</sub>=0V, V<sub>DD</sub>=2.8V, T<sub>OPR</sub> = -20 ~ 70°C

Item	Symbol	Min.	Typ.	Max.	Unit
Supply power for logic	V <sub>DD-Vss</sub>	2.8	3.3	3.6	V
I/O power supply	i <sub>ovcc</sub>	2.8	3.3	3.6	
Input high voltage	V <sub>IH</sub>	0.8i <sub>ovcc</sub>	-	V i <sub>ovcc</sub>	
Input low voltage	V <sub>IL</sub>	-0.3	-	0.2i <sub>ovcc</sub>	
Output high voltage	V <sub>OH</sub>	0.8I <sub>OVCC</sub>	-	-	
Output low voltage	V <sub>OL</sub>	-	-	0.2V <sub>DD</sub>	
Logic current consumption	I <sub>DD</sub>	-	15	40	mA
Current consumption during Sleep mode	I <sub>s</sub>	-	12.2	19	uA



## Module Function Description

### 7.1 MIPI interface

Pin No.	Symbol	Description	When not in use
1	LEDA	B/L positive pin	--
2	LEDK	B/L negative pin	--
3	VDD	Power supply, 2.8-3.3V type.	--
4	GND	Power Ground	--
5	D0N	MIPI DSI differential data pair.	--
6	D0P		--
7	GND	Power Ground	--
8	CLKN	MIPI DSI differential clock pair.	--
9	CLKP		--
10	GND	Power Ground	--
11	D1N	MIPI DSI differential data pair.	--
12	D1P		--
13-33	GND	Power Ground	--
34	RESET	Reset the LCM	--
35-37	GND	Power Ground	
38	VDD	Power supply, 2.8-3.3V type.	
39	GND	Power Ground	--
40	NC	dummy	--



## 7.2 RGB interface

Pin No.	Symbol	Description	When not in use
1	LED A	B/L positive pin	--
2	LED K	B/L negative pin	--
3	VDD	Power supply, 2.8-3.3V type.	--
4-13	GND	Power Ground	--
14	VS	Frame synchronizing signal	--
15	HS	Line synchronizing signal	--
16	Pclk	Dot clock signal	--
17	DE	Data enable signal for RGB interface operation Low: access enabled High: access inhibited	Power Ground
18-22	B0-B4	5bit B data input	
23-28	G0-G5	6bit G data input	
29-33	R0-R4	5bit R data input	--
34	RESET	Reset the LCM	--
35	CS	A chip select signal	
36	SCL	Serial clock	
37	SDA	Serial data input/output bidirectional pin	
38	GND	Power Ground	
39	VDD	Power supply, 2.8-3.3V type.	
40	NC	dummy	





## 8. Timing Characteristics

Please refer to the IC DATA SHEET of this module!

## 2 Backlight Characteristic

### 9.1 Power supply for led backlight

### 9.2 Absolute maximum rating

PARAMETER	SYMBOL	SPECIFICATIONS	UNIT
POWER DISSIPATION	PD	Vled X 20mA	mW
OPERATION TEMPERATURE	TOPR	-20°C ~ +70°C	°C
STORAGE TEMPERATURE	TSTG	-30°C ~ +80°C	°C

### 9.3 Electrical characteristics

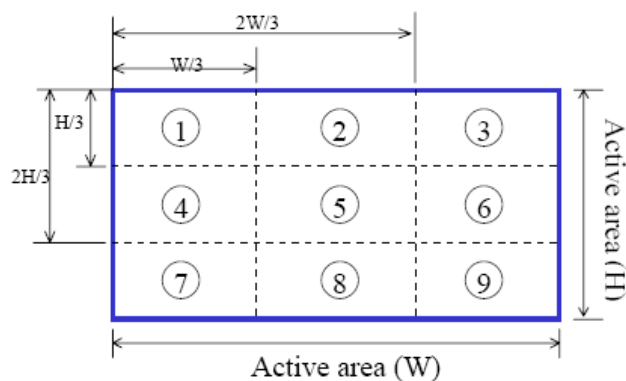
Item	Symbol	Min	Typical	Max.	Unit
LEDmodule forward Voltage	V <sub>LED</sub>		<b>3.0-3.3</b>		<b>V</b>
LED module current	I <sub>LED</sub>	45	<b>60</b>	75	<b>mA</b>
LCM Surface brightness Luminance ▼1	L <sub>S</sub>	----	<b>400</b>	----	<b>Cd/m<sup>2</sup></b>
LCM Surface brightness uniform ▼2	L <sub>D</sub>	----	<b>80</b>	----	<b>%</b>

#### ▼1 Test condition is:

- (a)Center point on active area
- (b)Best Contrast

#### ▼2 Uniform measure condition:

- (a)Measure 9 point.Measure location is show below:
- (b)Uniform=(Min.brightness/Max.brightness)\*100%
- (C)Best Contrast.





## 10. Optical Specification

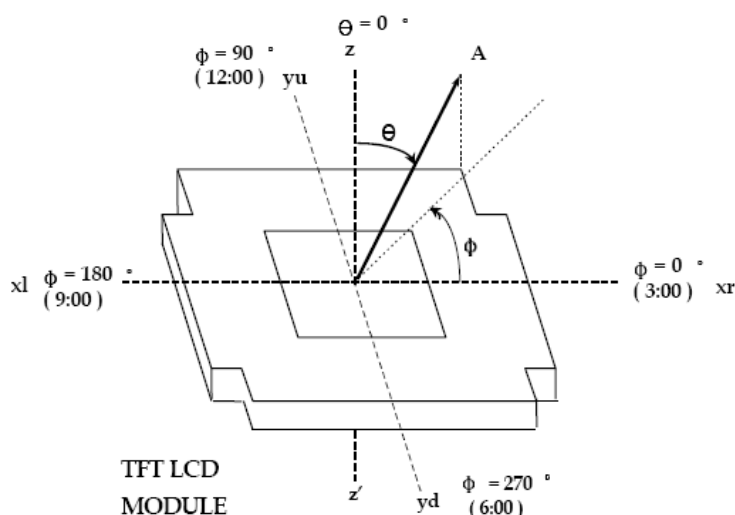
Optical characteristics are determined after the unit has been on and stable for approximately 30 minutes dark environment at 25°C. The values specified are at an approximate distance 500mm from the LCD surface at a viewing angle and  $\theta$  equal to 0

### 10.1 LCD Optical Characteristics

Ta=25°C							
parameter		Symbol	Condition	Min	Typ	Max	Unit
Viewing Angle	$\Phi=3$ O'clock	$\theta$	$Cr > 10$	70	80	-	deg
	$\Phi=6$ O'clock			70	80	-	
	$\Phi=9$ O'clock			70	80	-	
	$\Phi=12$ O'clock			70	80	-	
Contrast ratio		Cr	$\theta=0$ $\Phi=0$	1000	1200	-	ms
Response time		Tr+Tf		-	30	40	
NTSC		%		55	65	-	
CIE(x,y) chromaticity	RED	X	$\theta=0$ $\Phi=0$	-0.02	0.653	+0.02	
		Y			0.322		
	GREEN	X			0.278		
		Y			0.579		
	BLUE	X			0.134		
		Y			0.134		
	WHITE	X			0.296		
		Y			0.338		

### 10.2 LCD Optical Characteristics

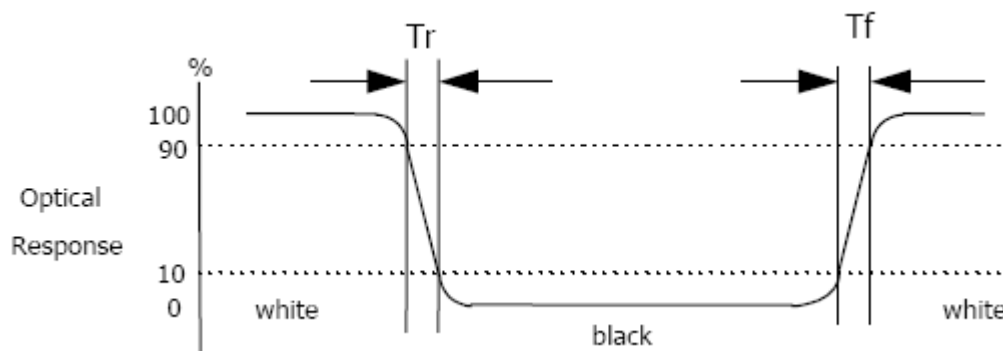
#### (1) LCD Viewing Angle



viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface.



## (2) Response time



Response time is the time required for the display to transition from white to black (Rising time, Tr) and from black to white (Falling time, Tf).for additional information

## (3) Contrast Ratio(CR)

Contrast Ratio(CR) is defined mathematically as:

$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

Surface luminance is the center point across the lcd surface 500mm from the surface with all pixels displaying white.

## 11. Reliability

### 11.1. Mtbf

The LCD module shall be designed to meet a minimum MTBF value of 50000 hours with normal.(25°C in the room without sunlight).

### 11.2. Test condition

NO.	ITEM	CONDITION	Cr
1	High Temperature Non-Operating Test	70°C*48Hrs	*No Defect Of Operational Function In Room Temperature Are Allowable.
2	Low Temperature Non-Operating Test	-20°C*48Hrs	
3	High Temperature/Humidity Non-Operating Test	50°C*90%RH*48Hrs	
4	High Temperature Operating Test	60°C*48Hrs	
5	Low Temperature Operating Test	-10°C*48Hrs	
6	Thermal Shock Test	-10°C(30Min) -25°C(5Min) -60(30Min)*2 Cycles	*IDD of LCM in Pre-and Post-test Should Follow Specification
7	ESD test	Voltage:±6KV R: 330Ω C:150pF Air discharge, 10time	

Notes:

- Judgments should be made after exposure in room temperature for two hours.



2. The distill water is used for the high temperature/humidity test.
3. The sample above is individually for every reliability tests condition.

## 12.PRECAUTIONS FOR USE OF LCD MODULES

### 12-1 Handling precautions

(1) The display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.

(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.

(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

(5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents :

- Isopropyl alcohol
- Ethyl alcohol

(6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.

- Water
- Ketone
- Aromatic solvents

(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

(9) Do not attempt to disassemble or process the LCD module.

(10) NC terminal should be open. Do not connect anything.

(11) If the logic circuit power is off, do not apply the input signals.

(12) To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
- The LCD module is coated with a film to protect the display surface.



Exercise care when peeling off this protective film since static electricity may be generated.

## 12-2 STORAGE PRECAUTIONS

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags (avoid high temperature / high humidity and low temperatures below 0 C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

## 12-3 OTHERS

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- Terminal electrode sections.

## 13. USING LCD MODULES

### 13-1 Liquid crystal display modules

LCD is composed of glass and polarizer. Pay attention to the following items when handling.

(1) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

(2) Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).

(3) N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.

(4) When the display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.

(5) Wipe off saliva or water drops immediately, contact with water over a long



period of time may cause deformation or color fading.

(6) Avoid contacting oil and fats.

(7) Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming in contact with room temperature air.

(8) Do not put or attach anything on the display area to avoid leaving marks on.

(9) Do not touch the display with bare hands. This will stain the display area and degrade insulation between terminals (some cosmetics are detrimental to the polarizers).

(10) As glass is fragile. It tends to become cracked or chipped during handling especially on the edges. Please avoid dropping or jarring.

### **13-2 Precaution for handling LCD modules**

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

(1) Do not alter, modify or change the shape of the tab on the metal frame.

(2) Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

(3) Do not damage or modify the pattern writing on the printed circuit board.

(4) Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

(5) Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

(6) Do not drop, bend or twist LCM.

(7) In order to avoid the cracking of the FPC, you should pay attention to the area of FPC(R50mm) where the FPC was bent. The edge of cover lay; the area of surface of Ni-Au plating, the area of soldering land and the area of through hole.

### **13-3 Electro-static discharge control**

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

(1) Make certain that you are grounded when handling LCM.

(2) Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.

(3) When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.

(4) When using an electric screwdriver to attach LCM, the screwdriver should be of ground potential to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.



(5) As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

(6) To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

### 13-4 Precautions for operation

(1) Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.

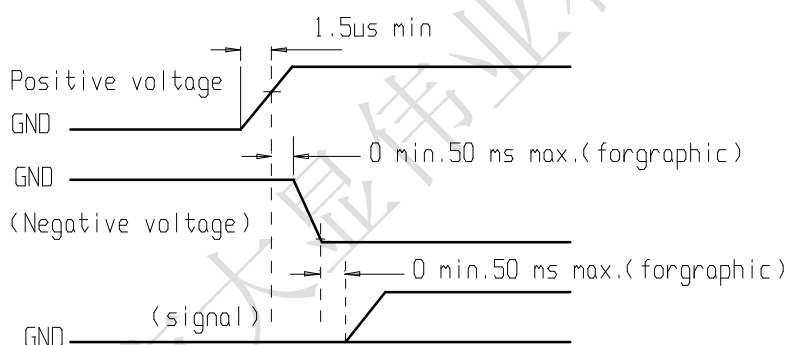
(2) Driving the LCD in the voltage above the limit shortens its life.

(3) Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.

(4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.

(5) Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40 C , 50% RH.

(6) When turning the power on, input each signal after the positive/negative voltage becomes stable.



### 13-5 Storage

When storing LCD as spares for some years, the following precaution are necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0 C and 35 C.

(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)

(4) Environmental conditions :

- Do not leave them for more than 160hrs. at 70 C.
- Should not be left for more than 48hrs. at -20 C.





### 13-6 Safety

(1) It is recommended to crush damaged or unnecessary LCD into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

### 13-7 Limited warranty

Unless agreed between DX and customer, DX will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with DX LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to DX within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DX limited to repair and/or replacement on the terms set forth above. DX will not be responsible for any subsequent or consequential events.

### 13-8 Return Lcm Under Warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- Circuit modified in any way, including addition of components.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB's eyelet, conductors and terminals.

## 14. Inspection standard

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM with touch pannel.

### 1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1 : 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 1.0

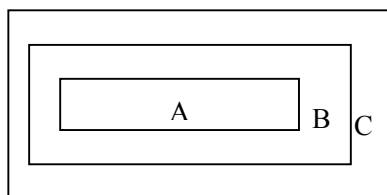
Minor defect: AQL 1.5

### 2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

### 3. Definition of inspection zone in LCD.





Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for

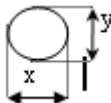
quality and assembly of customer's product.

#### 14.1 Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
14.1.1	All functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Back-light no lighting, flickering and abnormal lighting.	Major
14.1.2	Missing	Missing component	
14.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	
14.1.4	linearity	No more than 1.5%	

#### 14.2 Cosmetic Defect



Item No	Items to be inspected	Inspection Standard	Classification of defects																				
14.2.1	<b>Clear Spots</b>  Black and white Spot defect  Pinhole,  Foreign Particle,  polarizer  Dirt	For dark/white spot, size $\Phi$ is defined  <div></div> as $\Phi = \frac{(x + y)}{2}$ <table><tr><th rowspan="2">Zone Size(mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td><math>\Phi \leq 0.1</math></td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td><math>0.10 &lt; \Phi \leq 0.2</math></td><td colspan="2">2</td></tr><tr><td><math>0.2 &lt; \Phi \leq 0.25</math></td><td colspan="2">1</td></tr><tr><td><math>\Phi &gt; 0.25</math></td><td colspan="2">0</td></tr></table>	Zone Size(mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.1$	Ignore		Ignore	$0.10 < \Phi \leq 0.2$	2		$0.2 < \Phi \leq 0.25$	1		$\Phi > 0.25$	0		Minor
	Zone Size(mm)	Acceptable Qty																					
		A	B	C																			
	$\Phi \leq 0.1$	Ignore		Ignore																			
	$0.10 < \Phi \leq 0.2$	2																					
	$0.2 < \Phi \leq 0.25$	1																					
	$\Phi > 0.25$	0																					
	<b>Clear Spots</b>  TP Dirt	<table><tr><th rowspan="2">Zone Size(mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td><math>\Phi \leq 0.1</math></td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td><math>0.10 &lt; \Phi \leq 0.15</math></td><td colspan="2">3</td></tr><tr><td><math>0.15 &lt; \Phi \leq 0.25</math></td><td colspan="2">2</td></tr><tr><td><math>0.25 &lt; \Phi</math></td><td colspan="2">0</td></tr></table>	Zone Size(mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.1$	Ignore		Ignore	$0.10 < \Phi \leq 0.15$	3		$0.15 < \Phi \leq 0.25$	2		$0.25 < \Phi$	0		
	Zone Size(mm)	Acceptable Qty																					
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$0.10 < \Phi \leq 0.15$	3																						
$0.15 < \Phi \leq 0.25$	2																						
$0.25 < \Phi$	0																						

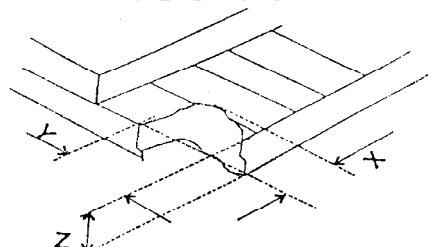
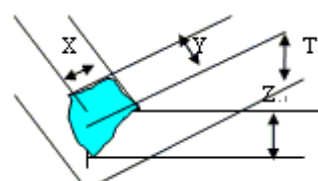


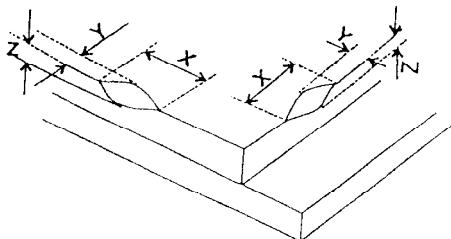
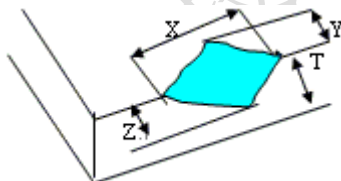
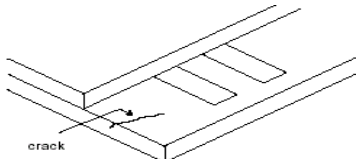
	<b>Dim Spots</b>  Circle shaped and dim edged defects	<table> <tr> <th rowspan="2">2. Zone Size(mm)</th><th colspan="3">Acceptable Qty</th></tr> <tr> <th>A</th><th>B</th><th>C</th></tr> <tr> <td><math>\Phi \leq 0.2</math></td><td colspan="3">Ignore</td></tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.40</math></td><td colspan="3">2</td></tr> <tr> <td><math>0.40 &lt; \Phi \leq 0.60</math></td><td colspan="3">1</td></tr> <tr> <td><math>0.60 &lt; \Phi</math></td><td colspan="3">0</td></tr> </table>	2. Zone Size(mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.2$	Ignore			$0.20 < \Phi \leq 0.40$	2			$0.40 < \Phi \leq 0.60$	1			$0.60 < \Phi$	0			
2. Zone Size(mm)	Acceptable Qty																									
	A	B	C																							
$\Phi \leq 0.2$	Ignore																									
$0.20 < \Phi \leq 0.40$	2																									
$0.40 < \Phi \leq 0.60$	1																									
$0.60 < \Phi$	0																									

Item No	Items to be inspected	Inspection Standard					Classification of defects
14.2.2	<b>Line defect</b>  Black line,  White line,  Foreign material on polarizer	size(mm)		Acceptable Qty			Minor
		L(Length )	W(Width)	zone			
				A	B	C	
		Ignore	$W \leq 0.02$	Ignore		Ignore	
		$L \leq 3.0$	$0.02 < W \leq 0.03$	2			
		$L \leq 2.0$	$0.03 < W \leq 0.05$	1			
			$0.05 < W$	Define as spot defect			



	Foreign material on TP film	The line can be seen after mobile phone in the operating condition:				
		size(mm)		Acceptable Qty		
		L(Length )	W(Width)	zone		
				A	B	C
		Ignore	$W \leq 0.03$	Ignore		Ignore
		$L \leq 5.0$	$0.03 < W \leq 0.05$	3		
			$0.05 < W$	Define as spot defect		
14.2.3	<b>Dim line defect</b>  Polarizer scratch  TP film scratch	If the scratch can be seen after mobile phone cover assembling or in the operating condition, judge by the line defect of 4.2.2.  If the scratch can be seen only in non-operating condition or some special angle, judge by the following.				
		Size(mm)		Acceptable Qty		
		L(Length)	W(Width)	Zone		
				A	B	C
		Ignore	$W \leq 0.03$	Ignore		Ignore
		$5.0 < L \leq 10.0$	$0.03 < W \leq 0.05$	2		
		$L \leq 5.0$	$0.05 < W \leq 0.08$	1		
			$0.08 < W$	0		

Item No	Items to be inspected	Inspection Standard	Classification of defects																				
14.2.4	Polarize Air bubble	<div>Air bubbles between glass &amp; polarizer</div> <table><tr><th rowspan="2">2. Zone Size(mm)</th><th colspan="3">Acceptable Qty</th></tr><tr><th>A</th><th>B</th><th>C</th></tr><tr><td><math>\Phi \leq 0.2</math></td><td colspan="2">Ignore</td><td rowspan="4">Ignore</td></tr><tr><td><math>0.20 &lt; \Phi \leq 0.30</math></td><td colspan="2">2</td></tr><tr><td><math>0.30 &lt; \Phi \leq 0.50</math></td><td colspan="2">1</td></tr><tr><td><math>0.50 &lt; \Phi</math></td><td colspan="2">0</td></tr></table>	2. Zone Size(mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.2$	Ignore		Ignore	$0.20 < \Phi \leq 0.30$	2		$0.30 < \Phi \leq 0.50$	1		$0.50 < \Phi$	0		Minor
2. Zone Size(mm)	Acceptable Qty																						
	A	B	C																				
$\Phi \leq 0.2$	Ignore		Ignore																				
$0.20 < \Phi \leq 0.30$	2																						
$0.30 < \Phi \leq 0.50$	1																						
$0.50 < \Phi$	0																						
14.2.5	Glass defect	<div>(i) Chips on corner A: LCD Glass defect</div> <div></div> <table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td><math>\leq 2.0</math></td><td><math>\leq S</math></td><td>Disregard</td></tr></table> <div>Notes: S=contact pad length</div> <div>Chips on the corner of terminal shall not be allowed to extend into the ITO pad or expose perimeter seal.</div> <div>B: TP Glass defect</div> <div></div> <table><tr><th>X(mm)</th><th>Y(mm)</th><th>Z(mm)</th></tr><tr><td><math>\leq 3.0</math></td><td><math>\leq 3.0</math></td><td>Disregard</td></tr></table>	X	Y	Z	$\leq 2.0$	$\leq S$	Disregard	X(mm)	Y(mm)	Z(mm)	$\leq 3.0$	$\leq 3.0$	Disregard	Minor								
X	Y	Z																					
$\leq 2.0$	$\leq S$	Disregard																					
X(mm)	Y(mm)	Z(mm)																					
$\leq 3.0$	$\leq 3.0$	Disregard																					

Item No	Items to be inspected	Inspection Standard	Classification of defects												
14.2.5	Glass defect	(ii) Usual surface cracks A: LCD Glass defect  <table border="1"><thead><tr><th>X</th><th>Y</th><th>Z</th></tr></thead><tbody><tr><td>≤3.0</td><td>&lt; Inner border line of the seal</td><td>Disregard</td></tr></tbody></table> B: TP Glass defect  <table border="1"><thead><tr><th>X(mm)</th><th>Y(mm)</th><th>Z(mm)</th></tr></thead><tbody><tr><td>≤6.0</td><td>&lt; 2.0</td><td>Disregard</td></tr></tbody></table>	X	Y	Z	≤3.0	< Inner border line of the seal	Disregard	X(mm)	Y(mm)	Z(mm)	≤6.0	< 2.0	Disregard	Minor
		X	Y	Z											
		≤3.0	< Inner border line of the seal	Disregard											
X(mm)	Y(mm)	Z(mm)													
≤6.0	< 2.0	Disregard													
(iii) Crack Cracks tend to break are not allowed. 	Major														

### 14.3 Parts Defect



Item No	Items to be inspected	Inspection Standard	Classification of defects
14.3.1	Parts contraposition	1、Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern. 2、Not allow chip or solder component is off center more than 50% of the pad outline.	Minor
14.3.2	SMT	According to the <Acceptability of electronic assemblies> IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.	